



DESCRIP : PATENT
TITLE : Solid-form perfuming compsn. - contains powder of spherical silicone resin, perfume and oily component
ASSIGNEE : SHISEIDO CO LTD
PACODE : SHIS
ACCNNO : 422095
DATE : 19971007
ABSTRACT : < BASIC> JP 9263525 A The composition contains 30-60 wt.% powder of spherical silicone resin, 5-25 wt.% perfume and oily component. ADVANTAGE - The composition has good shelf stability and stability of fragrance. Dwg.0/0
COPYRIGHT: FOR INTERNAL USE ONLY - PORTIONS COPYRIGHT BY DERWENT INTERNATIONAL LIMITED - 1997
PNBASIC : J09263525
PRIORNO : J09699436
DATEPR : 19960328
EQUIVDOC : **J09263525** J09699436 JPAT
SUBJECT : SOLID FORM COMPOSITION CONTAIN SPHERE RESIN OIL SSA
SUBJECTP : Personal Care; Si-Resin; Si-Resin
LANG : JAPANESE
TYPE : PTNT
IPCODE : A61K-007/46; C11B-009/00
DPCODE : A26; A96; D21
MANUAL : A06-A00E3; A12-V04C; D08-B
YEAR : 1997
YEARPR : 1996
COMMENT : 97-545470/50 < XRAM> C97-174060
RDATEMD : Nov 13, 2001
RDATENT : Feb 16, 1998
UPDATER : TDD

1/4/1

FN- DIALOG(R)File 347:JAPIO|
CZ- (c) 1999 JPO & JAPIO. All rts. reserv.|
TI- VIBRATION ISOLATING COMPOSITION
PN- 10-251517 A-
PD- September 22, 1998 (19980922)
AU- AKAMATSU SHOJI; TATEISHI MARI
PA- TORAY DOW CORNING SILICONE CO LTD [328967] (A Japanese Company or Corporation), JP (Japan)
AN- 09-082117 -JP 9782117-
AD- March 14, 1997 (19970314)
IC- -6- C08L-083/04; C08K-007/16; F16F-015/02
CL- 14.2 (ORGANIC CHEMISTRY -- High Polymer Molecular Compounds); 22.2 (MACHINERY -- Mechanism & Transmission)
KW- R047 (CHEMISTRY -- Liquid Rubber); R138 (APPLIED ELECTRONICS -- Vertical Magnetic & Photomagnetic Recording)
AB- PROBLEM TO BE SOLVED: To obtain the subject composition having excellent vibration isolating characteristic even under the variation of the vibration frequency and useful as a cushioning material for electrical equipment by compounding a viscous liquid and a specific solid powder.

SOLUTION: This composition is composed of (A) 100 pts.wt. of a viscous liquid (preferably a silicone oil) and (B) 5-200 pts.wt. of a solid powder having an average particle diameter of 0.1-100.mu.m and containing <=1wt.% of fraction having particle diameter of <=10.mu.m and >=10wt.% of fraction having particle diameter of >=30.mu.m. The composition is producible e.g. by kneading the component A with the component B using a kneader such as a ball mill. The composition may be incorporated with other component such as clay.